COMBINED DECLARATION AND POWER OF ATTORNEY

	ed inventor, I hereby declar	re that:				
I believe I am the plural names are	e original, first and sole inv listed below) of the subjec CTION DEVICE, ANAI	ct matter which is claimed	next to my name. Is listed below) or an original, fir and for which a patent is sough METHOD, AND ANALYSI	t on the invention		
\boxtimes	is attached hereto.					
	was filed on as Application Serial No					
	and was amended on	(if applicable).				
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.						
I acknowledge the Regulations, § 1.	•	ntion which is material to t	he patentability as defined in T	itle 37, Code of Federal		
I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:						
Prior Foreign Ap	plication(s)			Priority Claimed		
2003-08640	Japan		26/03/2003			
(Number)	(Country)	(Day	y/Month/Year Filed)	Yes No		
I hereby claim th	e benefit under 35 U.S.C.	§ 119(e) of any United Sta	tes provisional application(s) lis	sted below:		
N/A		N/A				
(Application Serial No.)						
(жррпса	tion Serial No.)	(Filing Date	2)			
I hereby claim the application design application is not paragraph of 35 U	ne benefit under 35 U.S.C. gnating the United States, t disclosed in the prior Un U.S.C. § 112, I acknowledge thich became available between the state of the sta	(Filing Date . § 120 of any United State , listed below and, insofa nited States or PCT Internate ge the duty to disclose info	es application(s), or § 365(c) of r as the subject matter of each ational application in the mann ormation which is material to paprior application and the nation	h of the claims of this er provided by the first tentability as defined in		
I hereby claim the application design application is not paragraph of 35 U 37 CFR § 1.56 w filing date of this	ne benefit under 35 U.S.C. gnating the United States, t disclosed in the prior Un U.S.C. § 112, I acknowledge thich became available between application: N/A	(Filing Date . § 120 of any United State . listed below and, insofa- nited States or PCT Intern- ge the duty to disclose info- ween the filing date of the N/A	es application(s), or § 365(c) of r as the subject matter of each ational application in the mannermation which is material to paprior application and the nation	h of the claims of this er provided by the first tentability as defined in hal or PCT International		
I hereby claim the application design application is not paragraph of 35 U 37 CFR § 1.56 w filing date of this	ne benefit under 35 U.S.C. gnating the United States, t disclosed in the prior Un U.S.C. § 112, I acknowledge thich became available between application:	(Filing Date Filing Date § 120 of any United State I listed below and, insofanted States or PCT Internates ge the duty to disclose information ween the filing date of the	es application(s), or § 365(c) of r as the subject matter of each ational application in the mannermation which is material to paprior application and the nation	h of the claims of this er provided by the first tentability as defined in nal or PCT International		
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Please address all correspondence and telephone calls to <u>Tadashi Horie</u> in care of:

Brinks Hofer Gilson & Lione P.O. Box 10395 Chicago, IL 60610 (312)321-4200 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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